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Docket No. 740819-634

#7/A
8-13-02
Mullish

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of:)
Koji ARITA et al.) Art Unit: 2813
Serial No. 09/938,528)
Filed: 08/27/2001) Examiner: D. Blum
For: METHOD FOR MANUFACTURING A)
SEMICONDUCTOR DEVICE)

CERTIFICATE OF MAILING

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9.30.2002

Adele M. Stamper
Adele M. Stamper

AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action mailed April 1, 2002, please amend the above identified application as follows.

IN THE CLAIMS:

✓
Please cancel claims 2 and 3.

Please amend claim 1 as follows:

SUB
B1
A1
1. (Amended) A method for manufacturing a semiconductor device, comprising the steps of:

forming, in a semiconductor layer formed on a first insulating film, an element isolation groove extending to the first insulating film;